

AT&S

RESULTS Q1 2023/24

CONFERENCE CALL

AUGUST 1, 2023

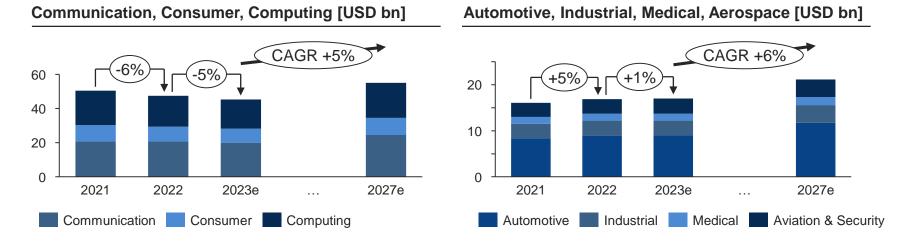
KEY DEVELOPMENTS Q1 2023/24

Quarter still reflects challenging market environment

- Q1 2023/24 was
 - Improved versus Q4 2022/23
 - Weak compared to Q1 2022/23
- Cost optimization program takes effect faster than expected
- Outlook 2023/24 confirmed, despite
 - Low visibility and high volatility
 - Continuation of price pressure
- Medium-term guidance 2026/27 confirmed
- New reporting structure successfully implemented



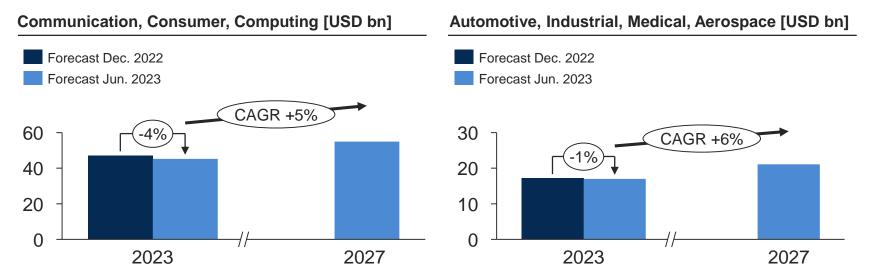
PCB MARKETS



- The general PCB market continues to be weak in 2023, with 3C market particularly under pressure
- Automotive sees a short term boost due to the shift of electrification and the improved supply chain. In Industrial
 and Medical, the market is expected to stagnate or decline this year
- Based on semiconductor market forecasts, PCB markets are expected to recover in 2024



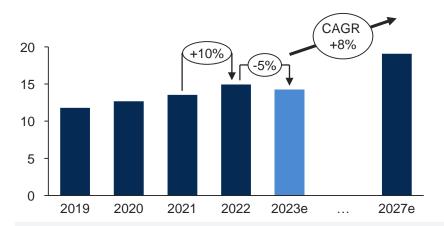
PCB MARKETS



- Market forecast for 2023 is revised slightly downward
- Price pressure expected throughout 2023
- Long term growth intact, driven by digitalization and energy efficiency trends

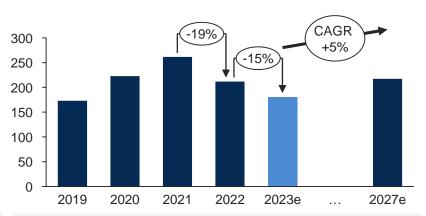
SUBSTRATE END MARKETS

Server shipment [mn units]



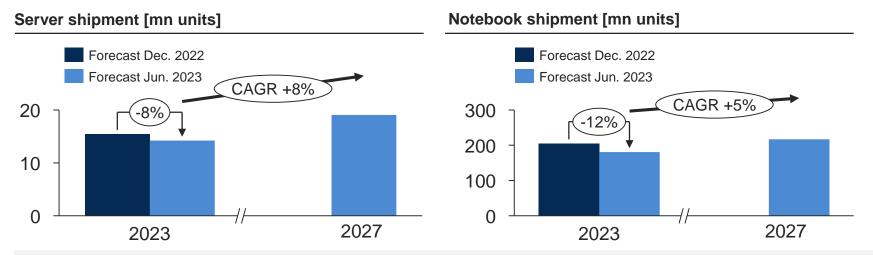
- CQ1 2023 below expectations due to low demand and a challenging macroeconomic environment
- Market recovery expected in 2024

Notebook shipment [mn units]



- Decrease of 2022 extends into 2023
- Shipment expected to reach bottom in CQ2-3 2023. New order recovery is expected in 2024, after the inventory level is normalized

SUBSTRATE END MARKETS



- Ongoing normalization of excess inventory and short-term orders decrease visibility
- Price pressure across all applications
- Driven by the increasing complexity of heterogeneous integration, the long-term growth of the value market is expected to be strong, particularly for high end application (Server/HPC/AI)
- AT&S positions its portfolio heavily towards server application

COST SAVING AND EFFICIENCY PROGRAMS

OPEX program

€440mn saving for FY23/24 and FY24/25 combined



Rapid execution enabled a stronger saving achieved in Q1 than expected. Savings from next quarters may slow down

Sustainable: One-third of the Q1 saving, stemming from intensified efficiency programs

Non-sustainable: Two-thirds of the Q1 saving, incl. SG&A, start-up cost, adjustment of labor force

CAPEX program

€450mn reduction, compared with the original plan, FY23/24 and FY24/25 combined

- Saving on track
- Mainly push-off of CAPEX investment, adjusted to market development
- FY 23/24 will peak CAPEX investment

LEOBEN HTB3 – PROGRESS

Milestones Q1

- Building constructed in record time of 14 months
- Bridge connecting to existing production plants established
- 60% of production floors already handed over
- 1/3 of production tools moved in
- Start of process qualification
- Move-in of first R&D tools



Facts & Figures

- High-end production for IC substrates & microelectronics packaging technologies
- Gross floor area: 39,000 sqm on 3 levels
- Cleanroom: 11,000 sqm ISO 5-8 (100* - 100,000)
- R&D-area: 2,300 sqm

Construction started: February 2022 Setting up first machines : April 2023 Start of production: 2024

LEOBEN HTB3

Construction progress



January 2023

April 2023

July 2023



KULIM PLANT 1 (K1) -**PROGRESS**

Milestones Q1

- Tools move-in into the first production plant K1 right on track
- 65 of 65 tools for line 1 / batch 1 already under installation
- Power-on at the largest substation of AT&S globally and in the Kulim **Hi-Tech Park**
- First Data Center in K1 goes live



Facts & Figures

- High-end production for IC substrates
- Gross floor area: 255,000 sqm
- Production area/cleanroom: 111,200 sqm ISO 5-7 (100* - 100,000)

Construction started: November 2021 Setting up first machines: February 2023 Moving into office: November/December 2023 Start of production: 2024





Construction progress



January 2023

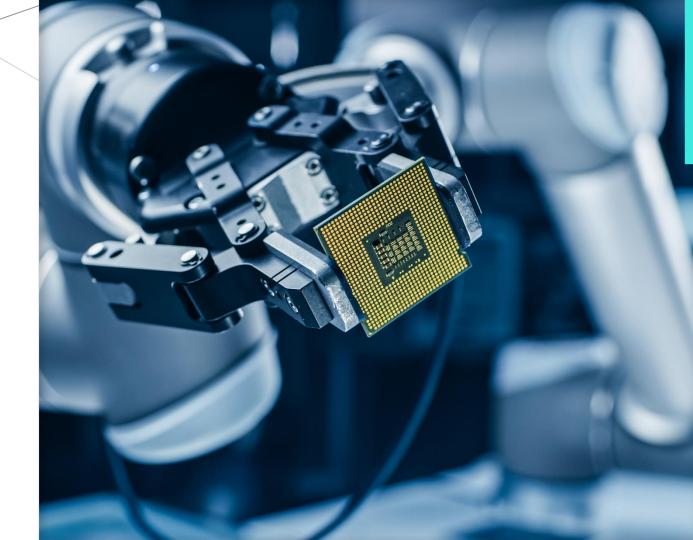
April 2023

July 2023



RESULTS Q1 2023/24

Petra Preining, CFO



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Q1 2023/24 RESULTS SUMMARY

Revenue

€ 362 MM

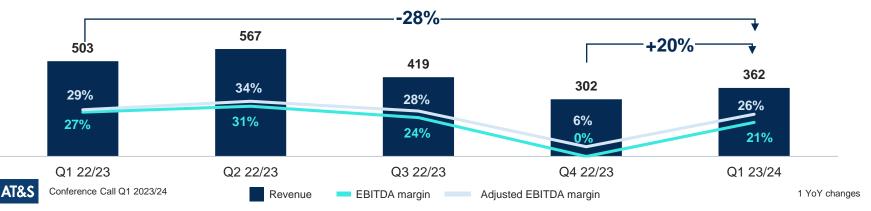
- Revenue¹ decreased by 28%
 -28% without currency effects
- Electronics Solutions: -26%
- Microelectronics: -31%

EBITDA
€ 75 MM

- EBITDA¹ decreased by 46%
 -57% without currency effects
- EBITDA margin: -6.6 pp \rightarrow 20.7%
- Adjusted EBITDA margin:
 -3.2 pp → 25.5%

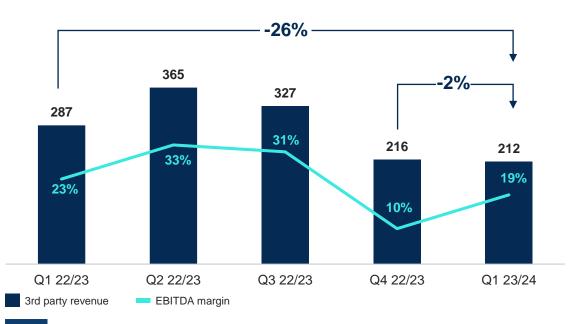
Net profit € -2 MM

- Net profit turned negative after € 96 MM in Q1 2022/23
- Driven by lower revenue and EBITDA



BUSINESS UNIT: ELECTRONICS SOLUTIONS

in € MM



Q1 23/24 vs. Q1 22/23

Revenue -26%: Former 'Mobile Devices' lack new products in spring Margin headwind by lower revenue

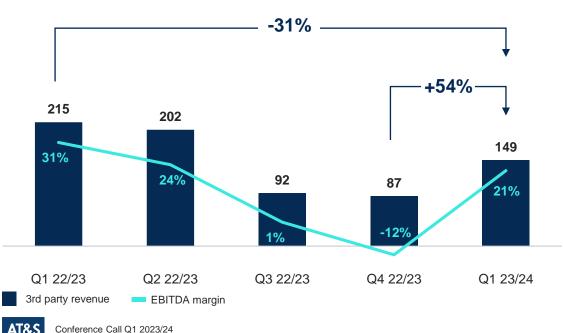
<u>Q1 23/24 vs. Q4 22/23</u> Stable **revenue** development

Cost optimization improves margin

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BUSINESS UNIT: MICROELECTRONICS





Q1 23/24 vs. Q1 22/23

Revenue decrease of 31% reflects weak market environment for IC substrates Margin headwind by lower revenue

Q1 23/24 vs. Q4 22/23

Revenue increase of 54% mainly driven by client application Cost optimization improves

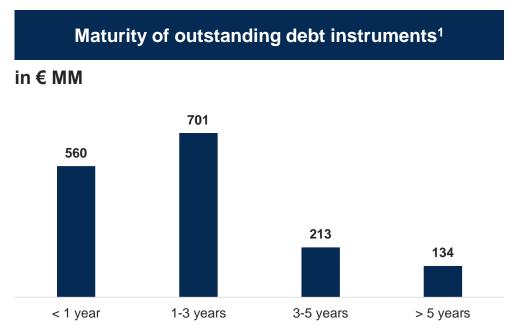
margin

Q1 2023/24 FINANCIAL POSITION

Cash & cash equivalents		Unused credit lines		Balancing capital allocation
in € MM ⁷⁹²		726	728	 Deploying capital with clear approach to invest in strategic growth markets Increased credit lines support financial capabilities
	630			 Solid financial structure with € 1,358 MM cash, cash equivalents and unused credit lines FX effects on funds impact financial results positive by € 5 MM
March 31, 2023	June 30, 2023	March 31, 2023	June 30, 2023	



DEBT FINANCING OVERVIEW



- 40% of debt instruments have a fixed interest rate
- Current financing costs of 3.6% (as of Q1 2023/24)
- Further customer prepayments expected
- Successful placement of Schuldschein (promissory note loan)
 - Volume: € 220 MM
 - 3-7 years: 160-210 bps p.a.² l fix: 5.3/5.4%
 - Margin step-up: +75bp if net debt/EBITDA >3.0x³

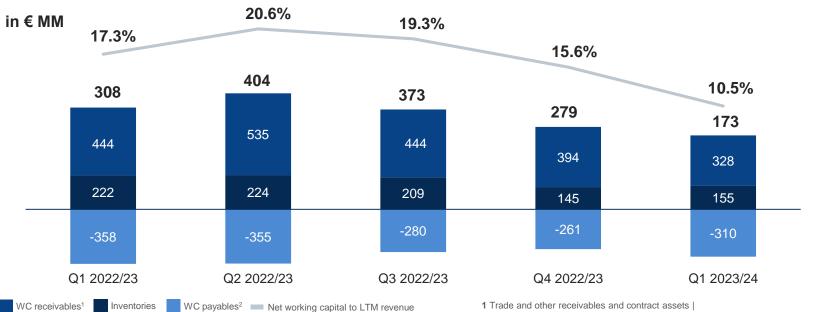
1 Amounts by maturity as of June 30, 2023. Promissory note loans, Term loans with banks, Bank borrowings and others; including accrued interest and placement costs and finance leases I

2 Floating: 6M Euribor (min. 0%) + final reoffer spread I Fix: EUR midswap (min. 0%) + final reoffer spread 3 And +/- 2.5 bps p.a. (non-cumulative), depending on ESG KPI achievement



FOCUS ON WORKING CAPITAL MANAGEMENT

Working capital and relation to revenue



2 Trade and other payables and other current provisions, without liabilities from investments

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BALANCE SHEET

€ MM	Mar. 31, 23	Jun. 30, 23	Change in %	
Total assets	4,162	4,004	-4%	Mainly driven by lower equity
Equity	1,158	1,025	-11%	Decrease due to FX effects
Equity ratio	27.8%	25.6%	-2.2pp	As anticipated below 30% target
Net debt	851	918	+8%	Net debt/EBITDA ratio of 2.6



CASH FLOW

€ MM	Q1 22/23	Q1 23/24	YoY Change in %	
CF from operating activities	206	229	+11%	Driven by lower working capital
CF from investing activities	-279	-313	+12%	
CF from financing activities	96	-76	-	Repayments of loans
Operating free CF ¹	-70	-43	-	
	276	272	-1%	

1 Cash flow from operating activities minus Net CAPEX

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CURRENT YEAR GUIDANCE

FY 2023/24	
Revenue	Approx. € 1.7–1.9 billion
Profitability	 Adjusted EBITDA margin of 25–29% Start-up effects of the Kulim and Leoben projects in the amount of approx. € 100 MM
Investments	Net CAPEX of up to € 1.1 billion



MID-TERM GUIDANCE

FY 2026/27	
Growth	Revenue approx. € 3.5 bn (CAGR +18%)
Profitability	 EBITDA margin of 27–32% ROCE of >12% with ramp-up of production
Others	 Net debt/EBITDA: <3 (can be temporarily exceeded) Equity ratio: >30% (may temporarily fall below)

THANK YOU FOR YOUR ATTENTION

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